

Renesas RA Family

RA Ethernet Design and Custom PHY Setup using FSP

Introduction

This application note describes Ethernet designs in general, provides a brief introduction to the RA Ethernet controller and interface to the PHY peripheral. It provides the design guidelines, when using the RA MCU with RMII modes for Ethernet specific applications.

The app note also covers the usage of FSP configurator to add the Ethernet module and configure it correctly. Additionally, it covers the adding new PHY to custom boards and software support using FSP.

App note also covers the usage of Wake-on-LAN (WOL) feature and using the LPM mode in Ethernet based designs. Finally, debugging of an Ethernet design based on RA is covered.

Applies to:

- RA MCU Group with Ethernet Peripherals

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1. Introduction to Ethernet Connectivity

Ethernet connectivity is one of the commonly used technologies in the data communications space, typically using a Local Area Network (LAN). Ethernet is based on the IEEE 802.3 standards supporting different speeds and mediums on which it runs. In recent years, Ethernet communication is used in home automation, industrial automation, and consumer electronics products. Ethernet is also used extensively in IoT applications as the default connectivity option. In Power over Ethernet (POE) based systems, power for the system can be derived from the communication line, without additional power connections for the system, which enables Ethernet as a perfect choice of connectivity for variety of applications as well.

1.1 General Overview

For networking connectivity challenges, Renesas Microcontrollers (MCUs) and Microprocessors (MPUs) with Ethernet support make it easy to implement Ethernet solution in your applications.

The Renesas RA group of microcontrollers (MCUs) uses the high-performance Arm® Cortex® core and offers Ethernet MAC with built in DMA, to ensure high data throughput.

Renesas RA Ethernet provides the following functionality:

- 10BASE-T/100BASE-TX IEEE 802.3 Compliant Ethernet
- Half- and full-duplex support
- Transmit/receive processing (Blocking and Non-Blocking)
- Auto-negotiation support
- Magic packet (Magic Pattern) detection mode support
- Flow control compliant with IEEE802.3x
- Media Independent Interface (MII), Reduced Media Independent Interface (RMII), compliant with the IEEE802.3u standard
- MDC/MDIO Management Interface for PHY Register Configuration
- Wake-on-LAN (WOL) signal output
- Hardware filtering of received multicast packets with a MAC address.

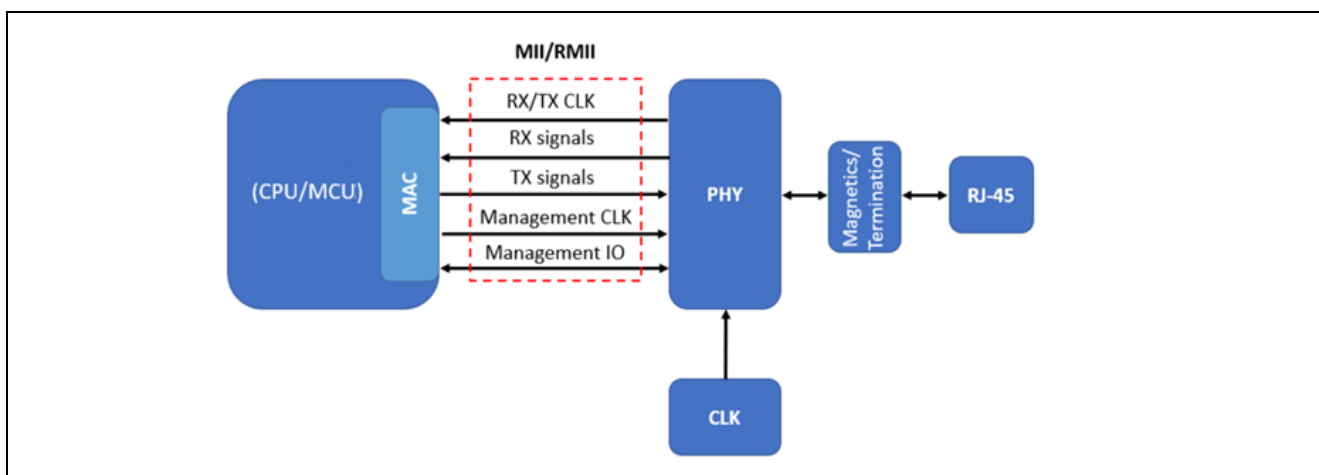


Figure 1. Ethernet Architecture Block Diagram

1.2 Ethernet MAC Controller

RA MCUs provide a one or two channel Ethernet Controller (ETHERC) compliant with the Ethernet or IEEE802.3 Media Access Control (MAC) layer protocol. Each ETHERC channel has one channel of the MAC layer interface. Connecting the MCU to the physical layer LSI (PHY-LSI) allows transmission and reception of frames compliant with the Ethernet/IEEE802.3 standard. The ETHERC is connected to the Ethernet DMA Controller (EDMAC), so data can be transferred without much intervention of the CPU. Figure 2 shows the RA Ethernet Module blocks.

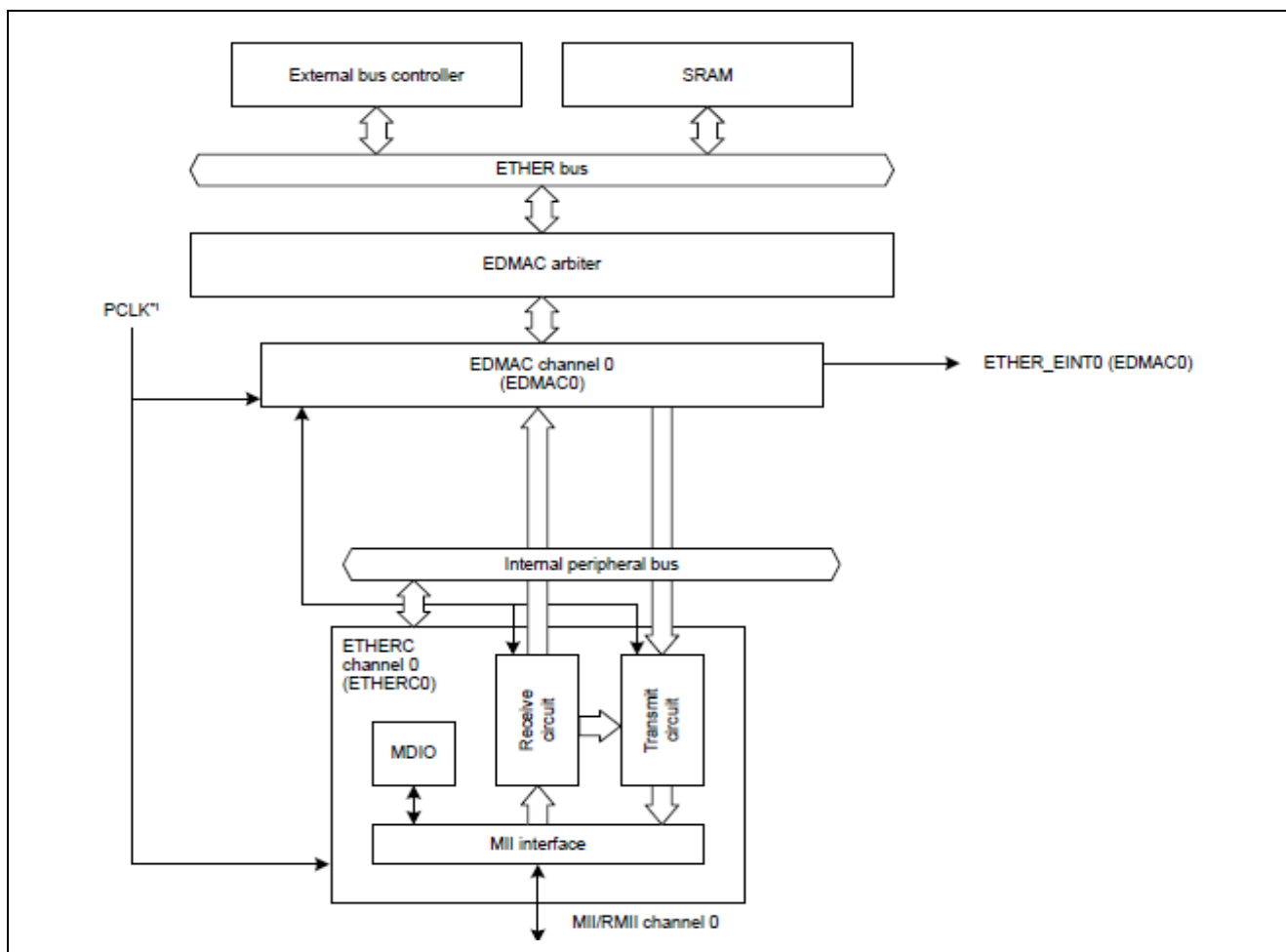


Figure 2. RA MCU Ethernet Controller Block Diagram

The Ethernet Media Access Controller (MAC) meets the essential protocol requirements for operating an Ethernet/IEEE 802.3-compliant node and provides an interface between the MCU host subsystem and the external Ethernet PHY.

The Ethernet MAC can operate in either 100-Mbps or 10-Mbps mode by supporting both half-duplex and full-duplex modes. When operating in half-duplex mode, the MAC complies fully with Section 4 of ISO/IEC 8802-3 (ANSI/IEEE standard) and ANSI/IEEE 802.3 standards. When operating in full-duplex mode, the MAC complies with IEEE 802.3x full-duplex operation standard.

The MAC also provides programmable enhanced features designed to minimize host supervision, bus utilization, and pre- or post-message processing. These features include the ability to disable retries after a collision, dynamic FCS (Frame Check Sequence) generation on a frame-by-frame basis, automatic pad field insertion and deletion to enforce minimum frame size attributes, and automatic retransmission and detection of collision frames.

The primary functionalities of the MAC are:

- Transmission and reception of encapsulated data messages
- Frame boundary delimitation, frame synchronization
- Error detection (physical medium transmission errors)
- Media control and access management
- Medium allocation (collision detection, except in full-duplex operation)
- Contention resolution (collision handling, except in full-duplex operation)
- Flow control during full-duplex mode
- Decoding of control frames (PAUSE command) and disabling the transmitter
- Generation of control frames
- Interfacing to the external PHY

1.3 Ethernet DMA Controller

RA MCUs provide a dedicated channel to the Ethernet DMA Controller (EDMAC) for the Ethernet Controller (ETHERC). The EDMAC controls most of the transmit and receive buffer management for communications. This reduces the load on the CPU and allows efficient data transmission and reception.

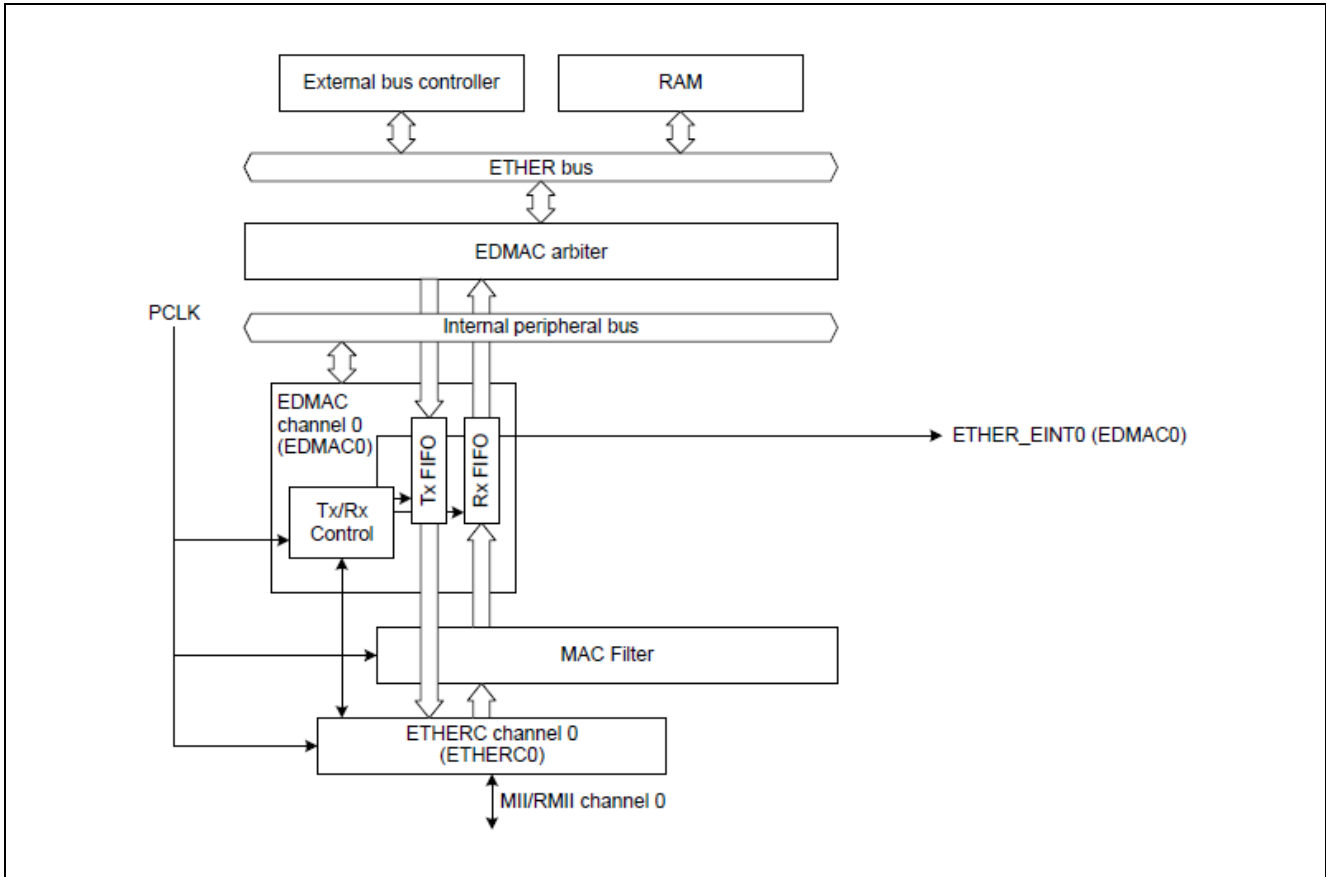


Figure 3. RA MCU Ethernet DMA Controller Block Diagram

The DMA controller uses descriptors to move data from the source address to the destination with little CPU intervention. DMA is designed for packet-oriented data transfer, such as frames in Ethernet. It supports single buffer frame transmission and reception (1 buffer per frame) and multi-buffer frame transmission and reception (multiple buffers per frame).

It minimizes system bus occupancy time using block transfer (32-byte units). It also writes back the transmit or receive frame state to descriptors and inserts padding in the receive data.

The controller can be programmed to interrupt the CPU, such as when the frame sending and receiving operations are completed, and under other normal / error conditions.

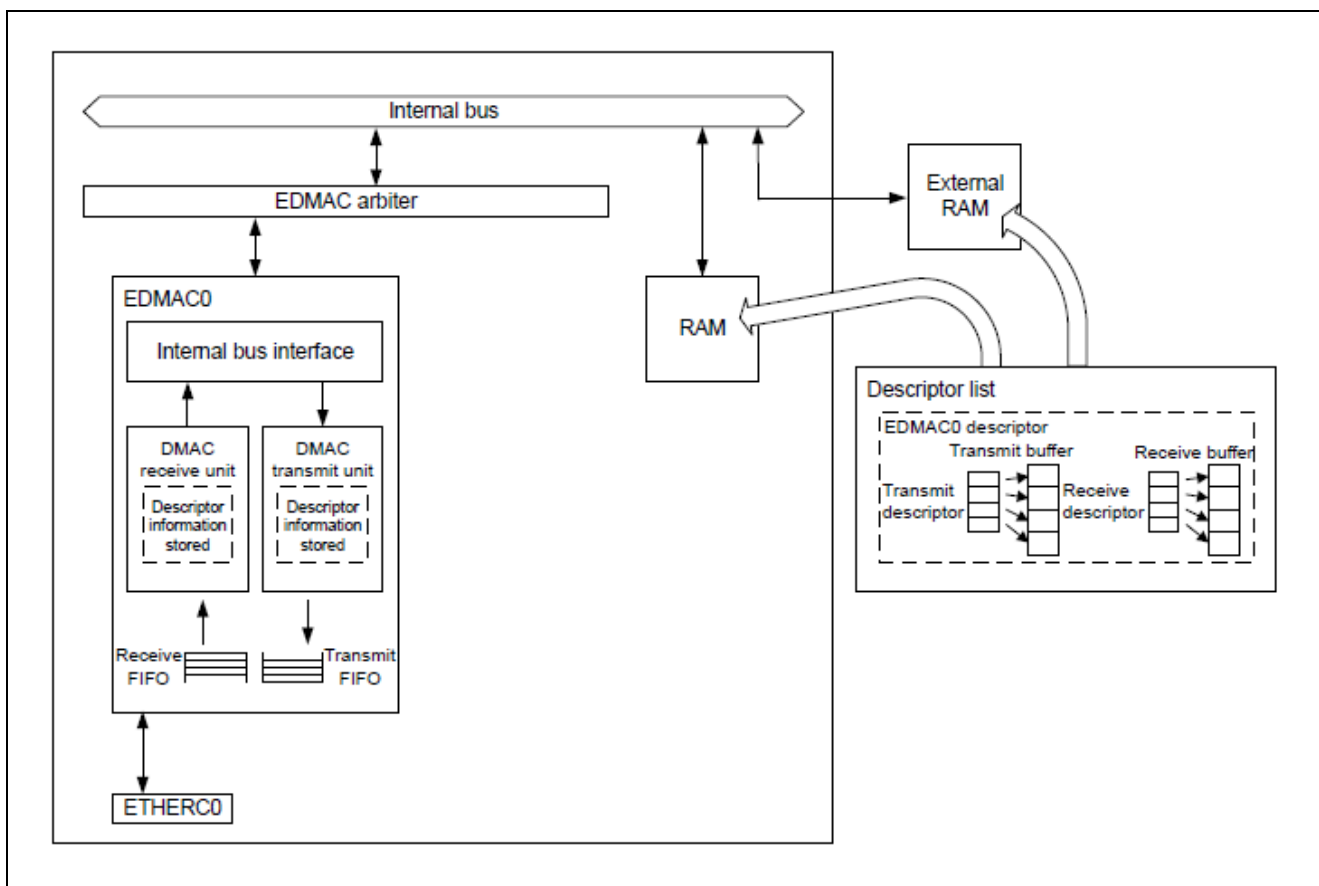


Figure 4. RA MCU Ethernet DMA Controller Block Diagram

1.4 Ethernet PHY

The PHY is the physical interface transceiver that implements the physical layer. The IEEE-802.3 standard defines the Ethernet PHY. It complies with the IEEE-802.3 specifications for 10BaseT (clause 14) and 100BaseTX (clauses 24 and 25).

The PHY sits between the media access controller (MAC) device, and the network connection. The MAC device can either be a microcontroller or a processor. The connection to the MAC layer can be a Media Independent Interface(MII) or a Reduced Media Independent Interface (RMII). These interfaces are defined in the IEEE 802.3 standard and offer either reduced number of signal lines, higher data speeds, or both.

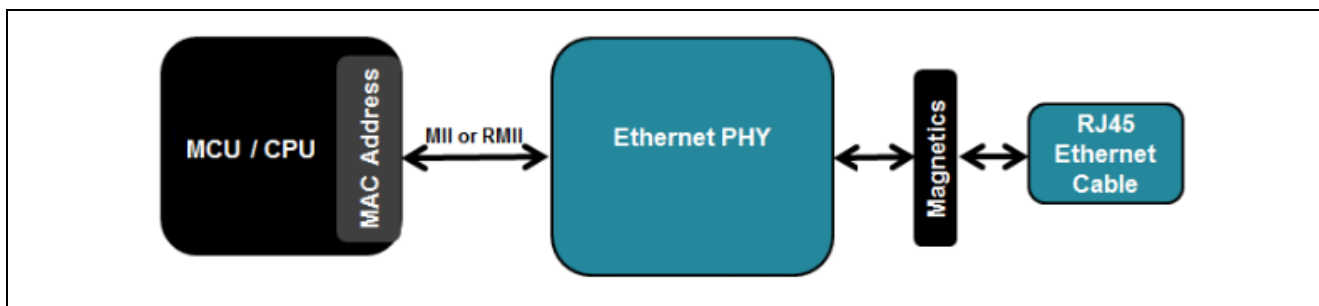


Figure 5. RA MCU Ethernet Interfacing to PHY Block Diagram

Functionally, the PHY can be divided into the following sections:

- 100Base-TX transmit and receive
- 10Base-T transmit and receive
- Internal MII/RMII interface to the Ethernet Media Access Controller
- Auto-negotiation to automatically determine the best speed and duplex possible
- Management Control (MDIO) to read status registers and write control registers.

2. General Design Guidelines

While designing an application using ETHERC and EDMAC on an RA MCU, there are some Hardware and Software guidelines that need to be followed. These guidelines are recommended best practices.

Due to the board size and number of pins required for Ethernet interface, users can choose RMII or MII. RMII uses 10 pins whereas MII uses 18 pins. This document focuses on RMII as it is more commonly used.

Proper clock source recommended for the MII and RMII is necessary with recommended accuracy of +/- 50 ppm.

The MCU also needs to select the proper clock source for the Ethernet controller; this can be accomplished for RA by selecting the proper clock source using FSP configurator within the allowed range. When using the ETHERC, set the clock to ICLK = PCLKA, and PCLKA needs to meet $12.5 \text{ MHz} \leq \text{PCLKA} \leq 120 \text{ MHz}$.

It is recommended to use the Link status pin in the design, so that a change in the link status can be handled in the software without much CPU intervention and implementation in the user code. Refer to the section 5.1 for details about configuring the link status handling using FSP.

Renesas has a separate application note that provides guidelines for interfacing from the Ethernet controller to a PHY transceiver, placement, signal routing, and different layers to handle the signals for isolation. This *Ethernet Hardware Design Guide* (R01AN3342EJ0101) document can be used as a reference during board designs.

Following are some hardware layout recommended guidelines:

- Although the trace length between the PHY and MAC is generally short enough to ignore transmission line effects, you should pay attention to impedance when routing the signal and clock traces when the traces are electrically long. The trace impedance for RMII/MII is 50 Ohms +/- 10%. This is the normal standard for most of the routing. Additionally in some designs, you may also notice series resistors of 30 Ohms.
- The differential Ethernet signals from the PHY to the connector must be impedance controlled, and those need to be 100-ohm differential impedance.
- Since MII and RMII require clock signals between the PHY and MAC, best practices for routing clock signals should be used with shorter trace length. Clock lines should also be shielded with GND lines to prevent crosstalk through capacitive coupling, especially when longer traces are necessary.
- All MII/RMII signal traces should be routed as short as possible on a single layer, and traces should be routed in a straight path. If you must turn a corner with a signal trace, the trace should bend by no more than 45 degrees. Clock lines should also be shielded with GND lines to prevent crosstalk through capacitive coupling, especially when longer traces are necessary.
- Because the TX and RX data signals are triggered by the rising edge of a clock, communication in MII and RMII is synchronous. Thus, the data lines and the clock line between the MAC and PHY should be length matched. The allowed deviation in length matching depends on the rise/fall time for digital signals between these two elements, although it is generally recommended that any deviation be less than 10 mm as MII and RMII use TTL logic. Again, the allowed trace length mismatch depends on the rise/fall time of digital signals.
- The final important point in distinguishing MII and RMII routing relates to the number of signals used in each standard. Some PHY devices support either standard, and so some of the pins on the PHY will be unused if you are using RMII. Your datasheets will tell you which pins need to be pulled-down and which can be safely left open. PHY Pin strapping is also required to be by use of external pullup resistors to attain the required latch-in during the device powerup and reset. Refer to PHY peripheral device user's manual for the available options.

2.1 Design Guidelines while using Arm TrustZone MCU

The design guidelines in this section are specific to some of the Arm® TrustZone® MCUs which needs special configurations to access the non-secure buffers.

For the RA MCU with EDMAC and Arm TrustZone support, the EDMAC peripheral can only be configured with the non-secure attribute, which is described by the Peripheral Security Attribution section in the User's Manual. Therefore, the EDMAC on these target devices always requires the non-secure buffers to be located in non-secure attributed RAM area.

Therefore, the RA serial boot interface (SCI/USB Boot Mode) needs to be accessible on the customer's board to program the IDAU register and setup the Arm® TrustZone® boundaries. This allows use of the Renesas Device Partition Manager to properly size the required non-secure memory partition in RAM.

2.2 Sample Design while using RA MCU with RMII

RMII is one of the most commonly used interfaces for Ethernet design due to the usage of lesser number of pins. Figure 6 shows the RA MCU used with RMII interface to connect with ICS1894-32 PHY transceiver device. For RMII, the REF50CK0 (50 MHz) clock is a required input signal instead of 25 MHz for MII.

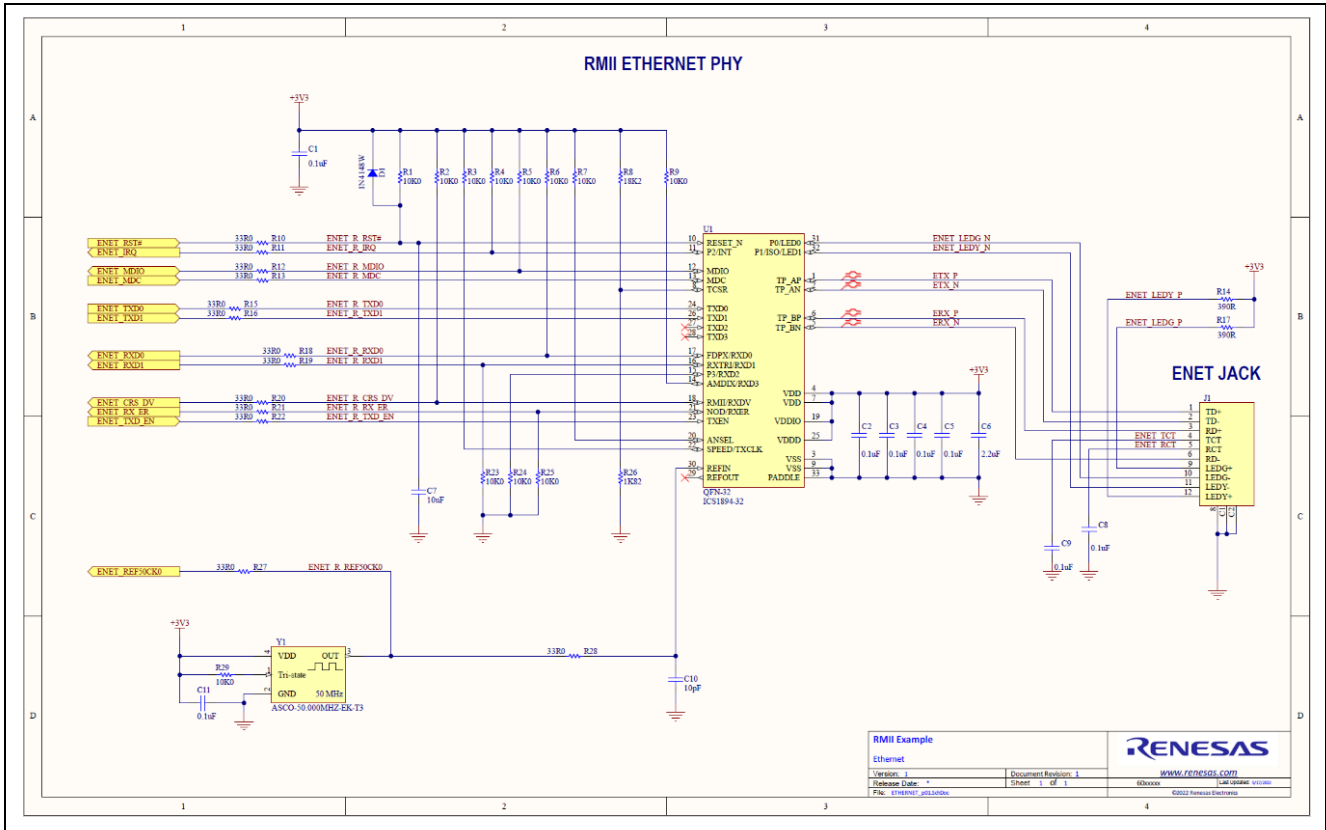


Figure 6. Sample RA MCU with RMII Interface for Ethernet

3. FSP Configuration for Ethernet Module

3.1 Ethernet Driver Configuration

This section has the FSP Ethernet configuration. Users are required to configure the selection based on the required modes. Details of each configuration is explained in detail in the [RA Flexible Software Package Documentation: Introduction \(renesas.github.io\)](#) under **Modules > Networking > r_ether** and **r_ether_phy**

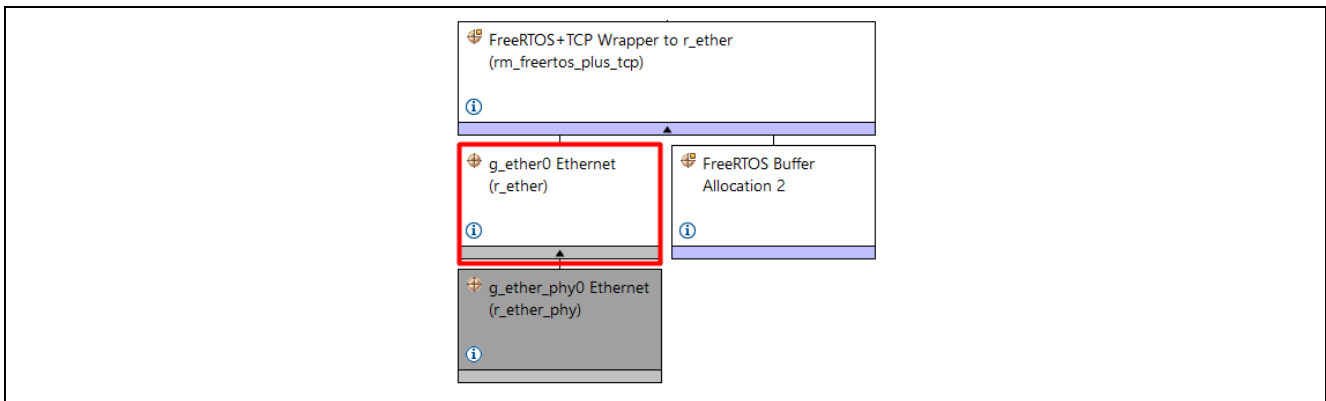


Figure 7. FSP Configuration for Ethernet

Table 1. FSP Configuration for Ethernet

Configuration	Options	Default	Description
Channel	0	0	Selects the ethernet channel number depending on the channel used in the design.
MAC address	Must be a valid MAC address	00:11:22:33:44:55	MAC address of this channel.
Zero-copy Mode	<ul style="list-style-type: none"> • Disable • Enable 	Disable	Enable or disable zero-copy mode.
Flow control functionality	<ul style="list-style-type: none"> • Disable • Enable 	Disable	Enable or disable flow control.
Multicast Mode	<ul style="list-style-type: none"> • Disable • Enable 	Enable	Enable or disable multicast frame reception.
Promiscuous Mode	<ul style="list-style-type: none"> • Disable • Enable 	Disable	Enable or disable this option to receive packets addressed to other NICs.
Broadcast filter	Must be a valid non-negative integer with maximum configurable value of 65535.	0	Limit of the number of broadcast frames received continuously
Number of TX buffer	Must be an integer from 1 to 8	1	Number of transmit buffers
Number of RX buffer	Must be an integer from 1 to 8	1	Number of receive buffers
Allocate RX buffer	<ul style="list-style-type: none"> • Disable • Enable 	Enable	Enable or disable the allocation of the RX buffer when generating the configuration structure
Buffer size	Must be at least 1514 which is the maximum Ethernet frame size.	1514	Size of Ethernet buffer
Padding size	<ul style="list-style-type: none"> • Disable • 1 Byte • 2 Bytes • 3 Bytes 	Disable	The padding size that is automatically inserted into the received packets
Padding offset	Must be less than 64 bytes.	0	The offset into a receive buffer to insert padding bytes.
Interrupt priority	MCU Specific Options	Priority 12	Select the EDMAC interrupt priority.
Callback	Name must be a valid C symbol	NULL	Callback provided when an ISR occurs

3.2 PHY Configuration

This section has the FSP configuration of the Ethernet PHY. The specific configuration details are shown in the table. The FSP provides a Default configuration for the ether PHY. For Custom boards, this needs to be configured based on the board design.

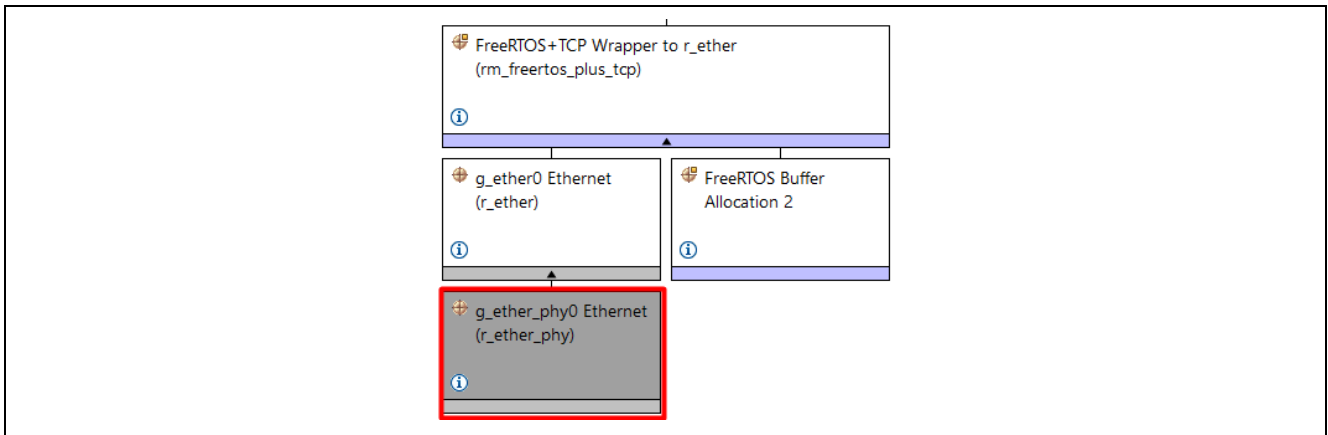


Figure 8. FSP Configuration for Ethernet PHY

Build Time Configurations for r_ether_phy

The following build time configurations are defined in `fsp_cfg/r_ether_phy_cfg.h`:

Table 2. Build Time Configuration for Ethernet PHY

Configuration	Options	Default	Description
Parameter Checking	Default (BSP) <ul style="list-style-type: none"> Enabled Disabled 	Default (BSP)	If the selected code for parameter checking is included in the build.
Select PHY (DEPRECATED) ¹	Default <ul style="list-style-type: none"> Other KSZ8091RNB KSZ8041 DP83620 ICS1894 	Default	Config -> Select PHY is deprecated. Enable support for a PHY in the Config section and select it with Module -> PHY LSI type. Set Select PHY to Default to hide this message.
KSZ8091RNZ Target	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Select whether to use KSZ8091RNB Phy LSI or not.
KSZ8041 Target	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Select whether to use KSZ8041 Phy LSI or not.
DP83620 Target	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Select whether to use DP83620 Phy LSI or not.
ICS1894 Target	<ul style="list-style-type: none"> Disabled Enabled 	Disabled	Select whether to use ICS1894 Phy LSI or not.
Reference Clock	Default <ul style="list-style-type: none"> Enabled Disabled 	Default	Select whether to use the RMII reference clock. Selecting 'Default' will automatically choose the correct option when using a Renesas development board.

¹ Note: Select PHY (DEPRECATED) will be removed from the FSP 4.1.0 release and all future releases. Instead, the “KSZ8091RNZ Target” or “KSZ8041 Target” or “DP83620 Target” or “ICS1894 Target” will be used based on the PHY LSI used on the board. For user specific PHY a new XML needs to be added to support the selection of new PHY.

Configuration	Options	Default	Description
Channel	<ul style="list-style-type: none"> 0 1 	0	Select the Ethernet controller channel number.
PHY-LSI Address	<ul style="list-style-type: none"> Specify a value between 0 and 31. 	0	Specify the address of the PHY-LSI used.
PHY-LSI Reset Completion Timeout	<ul style="list-style-type: none"> Specify a value between 0x1 and 0xFFFFFFFF. 	0x00020000	Specify the number of times to read the PHY-LSI control register while waiting for reset completion. This value should be adjusted experimentally based on the PHY-LSI used.
Select MII type	<ul style="list-style-type: none"> MII RMII 	RMII	Specify whether to use MII or RMII.
PHY LSI type	<ul style="list-style-type: none"> Kit Component DEFAULT KSZ8091RNB KSZ8041 DP83620 ICS1894 	Kit Component	Select the PHY LSI target. Selecting 'Kit Component' will automatically choose the correct option when using a Renesas development board.
MII/RMII Register Access Wait-time	<ul style="list-style-type: none"> Specify a value between 0x1 and 0x7FFFFFFF. 	8	Specify the bit timing for MII/RMII register accesses during PHY initialization. This value should be adjusted experimentally based on the PHY-LSI used.
Flow Control	<ul style="list-style-type: none"> Disable Enable 	Disable	Select whether to enable or disable flow control.

3.3 Adding a New PHY Device

Adding a new PHY device to an RA design requires changes in the hardware and software (FSP).

Hardware:

Follow and adopt the aforementioned design guidelines for the selected RMII interface. Reference designs from Renesas can be used as a basis while developing the custom boards. Below are some of the important considerations.

PHY pins need to be strapped to configure the board to the required modes of operation and for PHY address selection. Strapping is the use of external pullup resistors to attain the required latch-in during the device powerup and reset. Refer to PHY peripheral device user's manual for the available options.

- PHY address configuration – FSP Ethernet Controller HAL treats the default PHY address as 0
- Mode configuration – The default operation mode of PHY after the Power-On Reset should support auto-negotiation(The speed and Mode are selected based on the negotiation with peer end).

Identify if the target RA device has the Arm® TrustZone® security features. Design needs to include the serial boot interface for configuring the IDAU (Implementation Defined Attribution Unit) registers.

When using a 25 MHz crystal on a PHY device, verify the drive level of the 25 MHz crystal clock. The drive level should be a minimum of 100 μ W. The higher, the better. To obtain the best performance from a 25 MHz clock source, it requires a 25.000 MHz clock accuracy of better than +/- 50 PPM over the entire temperature range of operation. Refer to the crystal oscillator data sheet for the details while selecting the device.

For the PCB layout, the serial termination resistors on RMI interface should be placed as close as possible with all drive pins of RMI.

For the differential pairs routing from PHY to transformer inside RJ45, it is better to try as much as possible to keep the impedance for TX pair and RX pair the same in the PCB layout.

Software:

Based on the existing PHY support provided by FSP, when the user adds new PHY device there are modifications required from the FSP end as well.

Generally, the PHY devices have the common set of General registers and the FSP can access them with the existing code with minimal addition of wrapper code. If the bits for some of these registers are different, then it is important to handle them correctly in code.

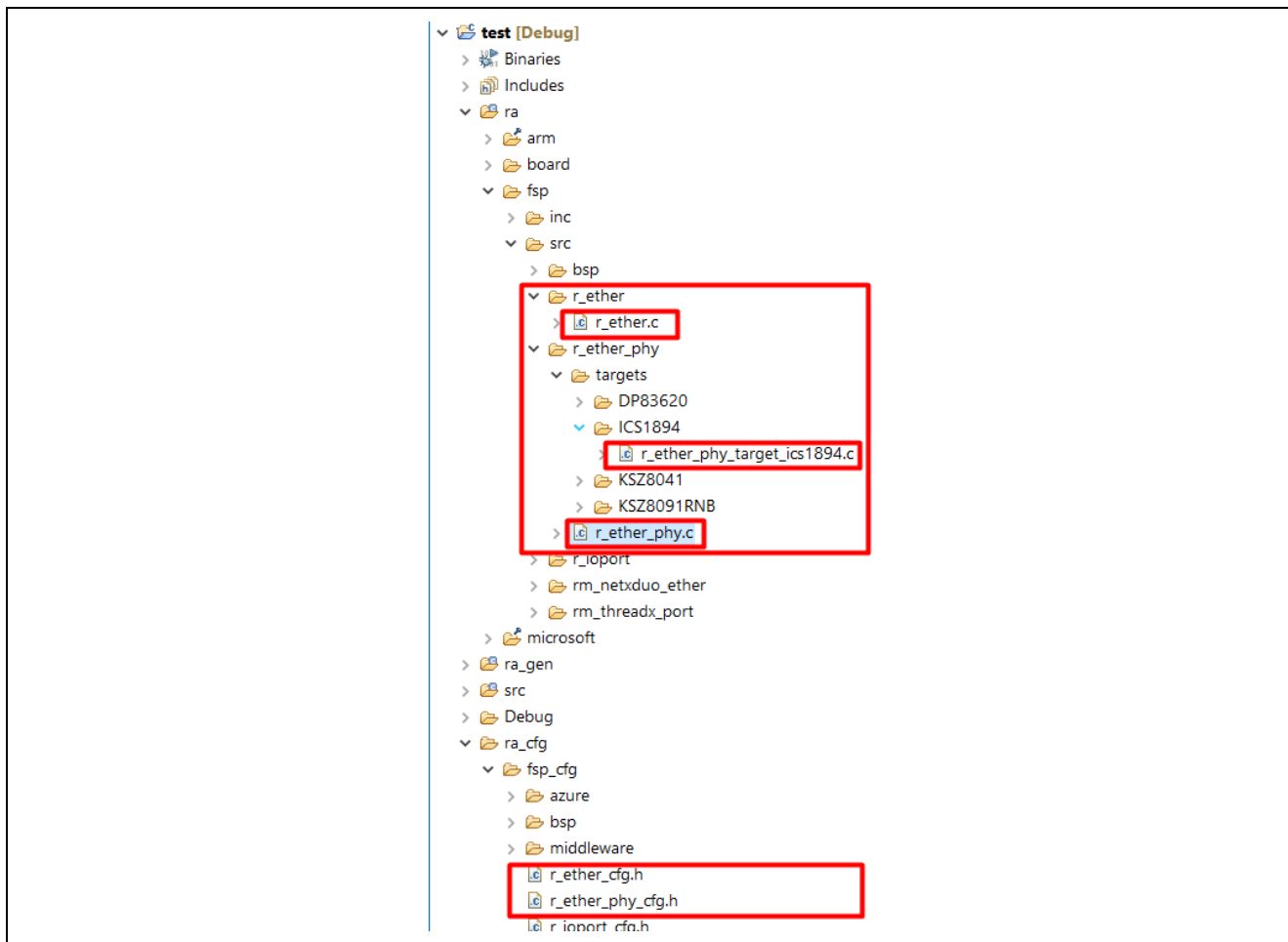


Figure 9. FSP Ethernet source code details

The FSP Ethernet file structure of the RA Ethernet and the supported PHY drivers are shown in the Figure 9. Fsp > src > r_ether > r_ether.c has the Ethernet driver and function call to the PHY driver.

Fsp > src > r_ether_phy > r_ether_phy.c has the generic API for the PHY and reading the PHY registers through the Management Data Input/Output (MDIO) interface. The code under these files remains the same even when you add the new PHY to the board.

The file fsp> src > r_ether_phy > targets > xxxxxxx > r_ether_phy_target_xxxxx.c is the specific driver related to the PHY under the target selection. When the user adds a new PHY to the board, the corresponding FSP driver needs to be created. For the new PHY support, create a new folder under r_ether_phy > target; refer to the existing supported target boards used in the FSP, and add the necessary code under this folder to operate new PHY device. Make them read-only so that FSP will not overwrite these files on Project Generation.

Also FSP allows to configure the ether_phy, based on the configurators and it creates the r_ether_phy_cfg.h, which has the user desired configurations made under the properties window of the ether_phy module. These properties can be used when configuring the new PHY.

After the PHY related code is finalized, if the finalized PHY code needs to be used across different versions of FSP, it is recommended to make it configurable using the FSP configurator. Therefore, a pack file needs to be created along with an xml for the user configuration. This can be accomplished by creating/modifying the FSP pack files. The creation of the FSP pack files are covered in different application note (**Getting Started with the Wi-Fi Modules on FSP** (r11an0486eu0100)) that users can refer to for more details.

Note: This Application Note does not have a bundled application to show case the reference code for the New PHY. Users can choose the different PHY from (**r_ether_phy > Select PHY**) using the FSP configurator and generate the code. Create 2 sets of projects and select different PHYs to compare the differences in the code under the folders listed in Figure 9. This also gives the changes required in the source code for the different PHYs.

Note: Adding a new PHY to the board does not require any changes to the Data path at the Ethernet and upper layers. FSP should work independent of the new PHY.

Note: Most of the HW reference designs provided by Renesas do not handle the LINK status pin. If the new design requires LINK status to be handled by the FSP, the HW needs to have the design in place connecting the LINK status pin from the PHY to the Ethernet Controllers ET0_LINKSTA. FSP has the associated configuration and code to handle this feature.

Note: In scenarios where the PHY does not provide the capability through hardware pin to report the Link status to the Ethernet controller, the users are required to handle the change in the link status by polling for the link status change in the application code. This can be done by periodically reading the Link status bit from the PHY register via the API (**R_ETHER_PHY_LinkStatusGet**).

3.4 Signal Drive Strength Configuration

The signal strength of the Ethernet pins used in pins configuration based on the Channel 0/1 needs to have the selection as drive capacity of "High". This can be done using the pin tab of the **FSP configurator Pins > Pin Function > Peripherals > Connectivity: ETHRC →ETHERC_RMII0/1**.

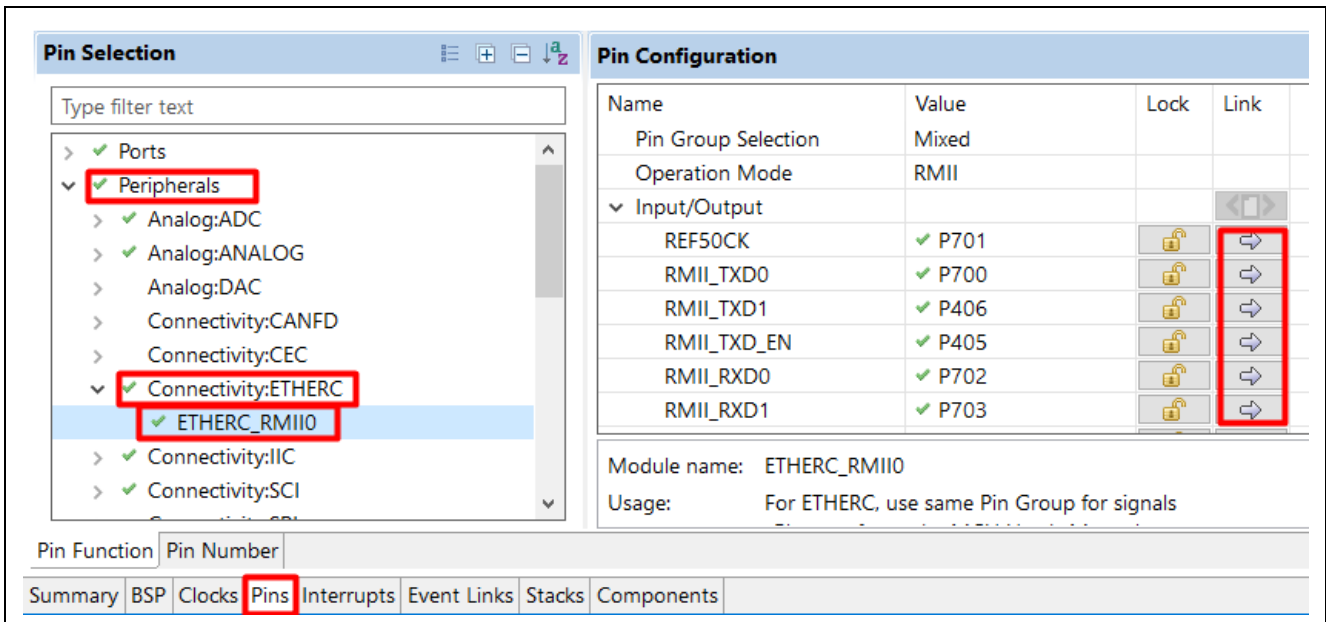


Figure 10. RA Ethernet Pin Drive Capacity Settings

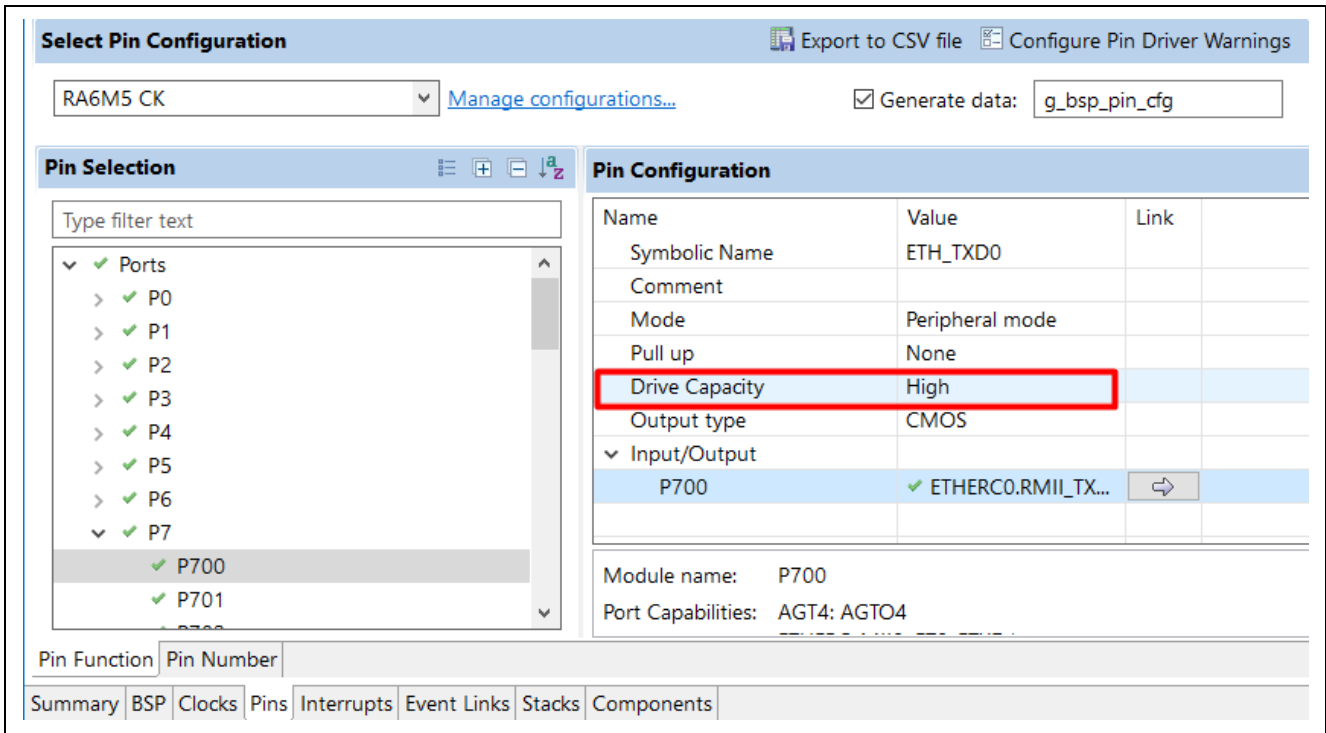


Figure 11. RA Ethernet Pin Drive Capacity Settings

4. Support of Low Power Modes and Wake-on-LAN

In RA-based Ethernet designs that require lower power implementations, we have two options to make it available for the customers.

Wake-on-LAN

Wake-on-LAN (WOL) keeps the Ethernet PHY in an active state but saves power by enabling the microcontroller (MCU), other components to power down selectively. These components are made to wake up when the Ethernet PHY receives a known “magic pattern” on the network. The *magic pattern* is a frame that is most often sent as a broadcast and contains anywhere within its payload 6 bytes of all 255 (0xFF 0xFF 0xFF 0xFF 0xFF 0xFF in hexadecimal), followed by sixteen repetitions of the target computer's 48-bit MAC address, for a total of 102 bytes.

The WOL feature enables users to save on overall system power while keeping the Ethernet transceiver awake when the system has well-defined trigger for wake ups.

Figure 12 shows a magic pattern scheme for which the Ethernet PHY will monitor ingress packets before signaling a wake up.

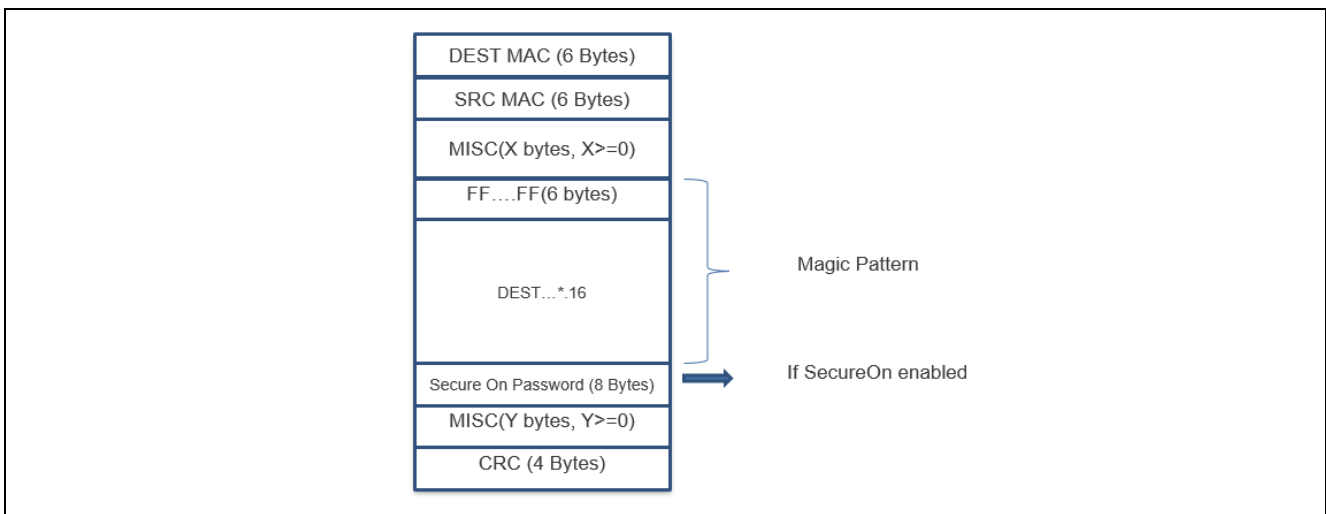


Figure 12. WOL Magic Pattern

The RA Ethernet controller supports Wake-on-LAN (WOL). WOL is a function to detect a Magic Pattern transmitted from a host device or other device, and to wake the MCU from a low power mode such as Sleep mode.

When the ETHERC detects a magic pattern, it outputs high on the ET0_WOL pin. Write 1 to the EDMAC0.EDMR.SWR bit to drive the ET0_WOL pin low.

Because a magic pattern is transmitted in broadcast mode, it is received regardless of the destination MAC address selected in the format. The ETHERC outputs high on the ET0_WOL pin only when the destination MAC address matches its own MAC address.

WOL implementation in RA can be accomplished by enabling this feature. This feature is available in the FSP Ethernet driver. Customers who want to use this feature need to configure the Ethernet with the API "wakeOnLANEnable". Refer to FSP User's manual for more details (7).

Energy-efficient Ethernet (IEEE 802.az):

This covers the details of Energy efficient Ethernet (EE) designed to save power when there is no traffic on the link. In Energy Efficient Ethernet, power is reduced when the port is down. Power is also reduced when the port is up and there is no traffic on it.

5. Debugging

5.1 Debugging RA Ethernet Controller using FSP

RA devices have integrated software support using the FSP. The devices are configured through the FSP configurator as mentioned in the previous sections. It is good practice to review the required Ethernet and PHY configurations are made for the device before debugging it. Refer the section 3 for more details for the Ethernet and PHY configurations.

Requirements for RA Ethernet Controller

For Arm® Cortex-M4 devices, when the Ethernet controller (ETHERC) and Ethernet DMA Controller (EDMAC) are used, PCLKA (Ethernet) must be in the range of 12.5 MHz to 120 MHz.

Ethernet (r_ether)

- If your Ethernet design has the Link status signal option available on the board, make sure you specify the LINK STATUS signal level coming from the PHY device and configure the appropriate signal level transition selection based on the PHY chip which is being used on the board.
- This is one of the important features which needs to be in the Ethernet design/application as it takes care of alerting the Ethernet controller when the link is up/down. Using this link status signal, Ethernet controller can send event/notification to the upper layer so that the data can be stopped or reinitiated at the different layers. Also when the link comes up after going down, the controller can initiate transmission of the data from the buffer to the wire.
- Renesas RA Ethernet has the code support for this feature in the FSP. In the absence of this feature in your hardware design, users are required to use the polling method to check the status of the Link and thereby take appropriate action on the data transmission and its control.

Usage of this feature can be turned ON/OFF using Link Signal Change Flag.

Table 2. RA Ethernet Controller Debug

Configuration	Options	Description
ET0_LINKSTA Pin Status Flag	Fall -> Rise / Rise -> Fall	Specify the polarity of the link signal coming from the output by the PHY-LSI.

Configuration	Options	Description
		When 0 is specified, link-up and link-down correspond respectively to the fall and rise of the LINKSTA signal. When 1 is specified, link-up and link-down correspond respectively to the rise and fall of the LINKSTA signal.
Link Signal Change Flag	Used / Unused	Use LINKSTA signal for detect link status changes: 0 = unused (use PHY-LSI status register) 1 = use (use LINKSTA signal)

- Channel selection for the Ethernet controller needs to be correct. By default, it is 0 and in the MCUs which have 2 Ethernet controllers, an appropriate selection needs to be made based on the hardware design.
- Valid MAC address selection is very important and needs to be unique to the devices on the network. Duplicate MAC address on the same network may result in undesired network behaviors. Renesas provides a test MAC address by default, and users are required to change it to their registered MAC address in the production boards.
- By default, FSP uses the zero-copy mode option for the data copied to the upper layers. This greatly improves the performance as there is no duplication of the data. Enough buffer memory needs to be allocated to handle the incoming continuous data stream.
- The ETHERC supports flow control compliant with IEEE802.3x and can transmit and receive PAUSE frames. By using the flow control, the packet loss can be minimized in the congested networks. FSP provides the default built-in configuration in the code.
- When the Multicast mode is enabled, multicast packets are received and passed to the upper layers. When disabled, multicast frames are not received. This is an important property when developing applications which require reception of multicast packets. Also, by using the broadcast filter, the number of broadcast frames received can be limited with the configurable value.
- When the ETHERC operates in promiscuous mode, it receives all valid frames regardless of whether the address matches the destination address, broadcast address, and multicast bit settings. This mode is mainly used for the sniffing of packets, debugging the network as it receives all the packets on the network. For normal application, this can be disabled to reduce the unnecessary processing.
- While using the ETHERC, it is good practice to optimize the size of the buffer memory required for transmitting and receiving Ethernet frames. FSP provides a way to allocate the TX and RX buffers required for the application. These can be selected by configuring the number of buffers (1 to 8) for both TX and RX and setting the desired size for each buffer. Default value is set to 1514 byte per buffer. Both of these values need to be modified to meet the application requirements.

5.2 Debugging Ethernet PHY using FSP

Some of the PHY specific configurations which need to be taken into consideration are given as follows. Refer to these sections for more details and depending on whether your board has these configurations.

Ethernet PHY (r_ether_phy)

- Channel selection to match the ETHERC channel being used in the design: by default it is 0. If the MCU supports 2 Ethernet channels, the proper selections need to be made to suit the design and for the proper communication to the device.
- PHY-LSI Address: All PHYs support the serial MDIO management interface. The MDIO pin is a bidirectional shared serial bus. Up to 31 PHYs can share this bus. Typically, only one PHY is connected to the bus. The selection of a PHY address (with which the PHY device is configured to operate) out of the 31 addresses, is required for proper 2-way communication.
- PHY-LSI Reset Completion Timeout: configure the datasheet recommended timeout value for the PHY.
- Selection Interface from MAC to the PHY: proper selection of RMII or MII needs to be in place as per the design.

- PHY LSI Type: It is important for custom boards to have the proper PHY LSI type selection. For Renesas evaluation boards, the default selection is made based on the “Kit Component” selection.
- MII/RMII Register Access Wait-time: Specify the bit timing for MII/RMII register accesses during PHY initialization. This value should be adjusted experimentally based on the PHY-LSI used. This is a critical value and should be selected as recommended in the datasheet of the custom PHY.
- Flow Control: If the flow control option is required, it must be selected accordingly.
- Verify that you are able to write and read from the PHY device with the PHY APIs provided by FSP. This can be verified using the protocol Analyzer (such as the Saleae logic analyzer) with a MDIO analyzer connecting the MDC and MDIO line.
- Consider adding temporary debugger breakpoints after each PHY API call, then validate the return code for success or failure, which may indicate a problem.
- Instrument the PHY driver code, by adding debug messages during debugging.

5.3 Debugging RA Ethernet Designs

Some considerations for debugging RA Ethernet designs are as follows:

- Review board designs with reference to the schematics. Verify the usage of the correct component values (resistors, capacitors and other passive components).
- Check for bad soldering (short or open), jumpers, damaged traces, improper component mounting, and so forth.
- Verify the VCC and GND for Ethernet PHY controller, also verify the Reset and Clock signals to the PHY.
- For prototype boards, it is best practice to test the pins and signals before running any IP level traffic tests.
- During the initial development stages. It is important to ensure the TX/RX signals at the RJ-45 connector are compliant with (802.3 Physical Layer Compliance). This can be done by using a logic analyzer or oscilloscope.
- Identify the selection of RMII/MII modes in the hardware and verify that the software (FSP) is configured to use the correct mode.
- Basic network connectivity can be checked using the proper cable connected between the RA board and host. If the Link LED turns ON, that means the connectivity is present.
- Ethernet LEDs: Green and Amber. These LEDs indicate the status of the Ethernet at the Physical layer. If the Green LED is solid, it indicates the Link presence. Blinking of the Amber LED indicates network activity.
- Loopback tests can be performed to validate the proper HW connections.
- Perform Ethernet MAC local loopback to verify the functionality of the MAC using this internal loopback. Set the ILB bit (Internal Loopback Mode) of the ECMR (ETHERC Mode Register) to perform this internal loop.
- Perform MAC+PHY loopback to verify the functionality of the PHY using this internal loopback. Refer to the PHY User’s manual for setting the loopback bit under Device Mode Control register.
- When Physical layer is up, the Ethernet connection can be debugged using TCP/IP and the Wireshark tools for data traffic. This can be performed by connecting the Ethernet port to a switch and connecting a PC with Wireshark tool to a switch, and connecting uplink of the switch to a LAN/router.
- Basic Ping operation from the PC can be initiated on the board’s IP address. Similarly, the ping utility can also be developed on the device side for debugging purposes.
- Run and analyze the Wireshark logs to review the ARP, and ICMP packets exchanged between the two devices. This will ensure the connectivity between the devices.
- Ping and trace route utility are a simple and best way to debug the connectivity. Ping tests with varying data sizes can be a good way to test and measure the performance and reliability of the code.
- Packet Generator tools like Spirent Network analyzer (<https://www.spirent.com/products/ethernet-ip-test-solutions>) can also be used to test the Ethernet. This can also be automated for stress testing with varying packet sizes. It also keeps a log of the number of packets sent, received, dropped and other errors.
- Without auto negotiation enabled, Ethernet mode and speed selection mismatch can also be an issue. For example, if the RA device is configured as half duplex or full duplex with 10/100 Mbps speed, but the other side does not use the same settings then there will be a problem during the communication.

- All the RA evaluation boards by default have an Auto Negotiation (AN) mode. Check that the AN bit is set after exchanging the link capability between the 2 devices. After the link negotiates the mode and speed, the AN bit will be set. This can be verified on the PHY side by monitoring the AN bit in the PHY registers.

6. FAQs

6.1 RA Ethernet FAQs

- Q: Does FSP support adding different PHYs to RA based Ethernet designs?
— A: FSP supports adding new PHYs to RA based Ethernet designs. The FSP has built-in PHY code wrapper functions to interface with the new PHY device.
- Q: Does RA support adding 2 Ethernet channels and 2 different PHYs?
— A: Some of the RA MCUs have 2 Ethernet channels and both can be used with different PHYs. FSP provides support for this.
- Q: Do I need to change the Ethernet driver code when a new PHY is used in the design?
— A: There is no need to change the Ethernet driver on the FSP side. However, when adding the new PHY, the PHY drivers will need small modifications depending on the PHY device.
- Q: Can I configure the mode and speed of the Ethernet devices using FSP Configurator?
— A: FSP configurator does not provide the option of configuring the Speed selection or Mode selection. It is by default in the auto negotiation mode.
- Q: Can I use the RA Ethernet with POE (Power over Ethernet) mode?
— A: RA Ethernet can be used in POE mode.
- Q: Can I use the RA Ethernet along with FSP for PPPoE (PPP over Ethernet) ?
— A: FSP does not support PPPoE. Adding support for PPPoE can be done in the software by using RA Ethernet as a PPPoE interface.
- Q: Does Renesas RA provides integrated PHYs for Ethernet designs?
— A: RA Ethernet only provides an Ethernet controller with MAC support. PHY support needs to be added separately. Please refer to the RA Evaluation kit design files and datasheets for more details.
- Q: Does Renesas RA provide support for MII interfaces?
— A: RA Ethernet provides support for MII/RMII and can be used with MII/RMII interface designs. However, users are recommended to thoroughly test the MII interface.
- Q: Does Renesas RA provides support for Low Power modes while using the Ethernet controller?
— A: Low Power modes are supported on Renesas RA MCUs while using the Ethernet controller. In addition, the Wake-on-LAN feature is also supported on RA MCUs. FSP has the support for the same.

6.2 Renesas Rulz

Refer to the following link for some of the answered questions from the Renesas Support teams:

<https://community.renesas.com/search?q=Ethernet&group=250#serp=2>

7. References

- [RA Flexible Software Package Documentation: Introduction \(renesas.github.io\)https://www.renesas.com/us/en/document/apn/rx-family-ethernet-hardware-design-guide-rev101](https://www.renesas.com/us/en/document/apn/rx-family-ethernet-hardware-design-guide-rev101)

8. Known Issues

This section talks about the known FSP and e²studio tool related issues. More details for any Ethernet related issues can be found at this link (<https://github.com/renesas/fsp/issues>).

Website and Support

Visit the following vanity URLs to learn about key elements of the RA family, download components and related documentation, and get support.

RA Product Information	renesas.com/ra
RA Product Support Forum	renesas.com/ra/forum
RA Flexible Software Package	renesas.com/FSP
Renesas Support	renesas.com/support

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Oct.06.22	—	Initial Release

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